STD26P3LLH6



P-channel 30 V, 0.024 Ω typ., 12 A, STripFET™ VI DeepGATE™ Power MOSFET in a DPAK package

Datasheet - production data

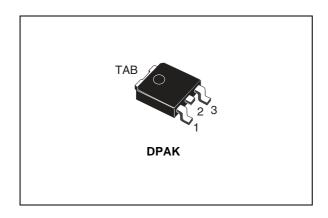
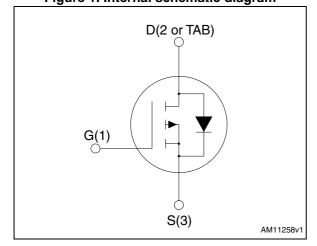


Figure 1. Internal schematic diagram



Features

Order code	V _{DSS}	R _{DS(on)} max	I _D	P _{TOT}
STD26P3LLH6	30 V	$0.030~\Omega^{(1)}$	12 A	40 W

- 1. @ V_{GS}= 10 V
- $\bullet \quad \mathsf{R}_{\mathsf{DS}(\mathsf{on})} \ ^* \ \mathsf{Q}_\mathsf{g} \ \mathsf{industry} \ \mathsf{benchmark}$
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- · Low gate input resistance

Applications

- · Switching applications
- LCC converters, resonant converters

Description

This device is a P-channel Power MOSFET developed using the 6^{th} generation of STripFET™ DeepGATE™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest $R_{DS(on)}$ in all packages

Table 1. Device summary

Order code	Marking	Package	Packaging
STD26P3LLH6	26P3LLH6	DPAK	Tape and reel

Note: For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

Contents STD26P3LLH6

Contents

1	Electrical ratings	. 3
2	Electrical characteristics	
3	Test circuits	. 8
4	Package mechanical data	. 9
5	Packaging mechanical data	13
6	Revision history	15

STD26P3LLH6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	30	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	12	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	8.5	Α
I _{DM} (1)(2)	Drain current (pulsed)	48	Α
P _{TOT} (1)	Total dissipation at T _C = 25 °C	40	W
T _{stg}	Storage temperature	-55 to 175	°C
T _j	Max. operating junction temperature	175	°C

^{1.} Limited by wire bonding.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	3.75	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
E _{AS}	Single pulse avalanche energy (starting T_J =25 °C, I_D =6 A, I_{AS} =12 A, V_{DD} =25 V, V_{gs} =10 V)	350	mJ

Note:

For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

^{2.} Pulse width limited by safe operating area.

Electrical characteristics STD26P3LLH6

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	30			٧
1	Zero gate voltage drain	V _{DS} = 30 V			1	μΑ
I _{DSS}	current (V _{GS} = 0)	V _{DS} = 30 V, Tc = 125 °C			10	μΑ
I _{GSS}	Gate body leakage current	$V_{GS} = \pm 20 \text{ V}, (V_{DS} = 0)$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V
B	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$		0.024	0.03	Ω
R _{DS(on)}		$V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		0.038	0.045	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1450	-	pF
C _{oss}	Output capacitance	V _{DS} = 25 V, f=1 MHz,	-	178	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0	-	120	-	pF
Qg	Total gate charge	V _{DD} = 24 V, I _D = 12 A V _{GS} = 4.5 V	-	12	-	nC
Q _{gs}	Gate-source charge		-	4.4	-	nC
Q_{gd}	Gate-drain charge	(see Figure 14)	-	5	-	nC
R _g	Gate input resistance	f = 1 MHz, gate DC Bias = 0, test signal level = 20 mV, I _D = 0	-	1.8	-	Ω

Note: For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

4/16 DocID023574 Rev 5

Table 7. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	15	-	ns
t _r	Rise time	$V_{DD} = 24 \text{ V}, I_D = 1.5 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	15	-	ns
t _{d(off)}	Turn-off delay time	$G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13)	-	24	-	ns
t _f	Fall time		-	21	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		12	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		48	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 12 A, V _{GS} = 0	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 12 A,	-	15		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/μs, V _{DD} = 16 V	-	6.5		nC
I _{RRM}	Reverse recovery current	(see Figure 15)	-	0.9		Α

^{1.} Pulse width limited by safe operating area

Note:

For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STD26P3LLH6

Electrical characteristics (curves) 2.1

Figure 2. Safe operating area

Figure 3. Thermal impedance

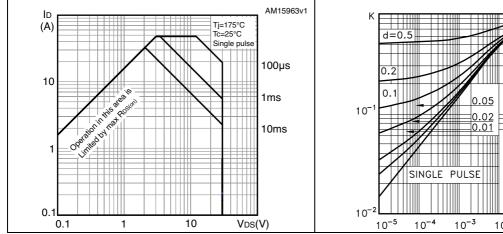


Figure 4. Output characteristics

Figure 5. Transfer characteristics

 $Z_{th} = k R_{thJ-c}$ $\delta = t_p / \tau$

 $10^{-1} t_p(s)$

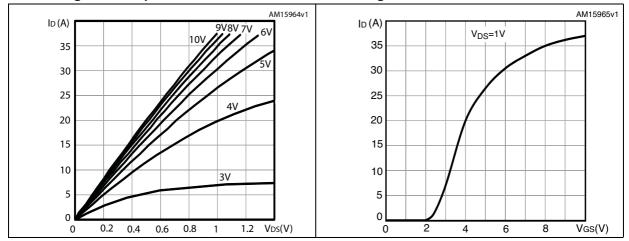


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance

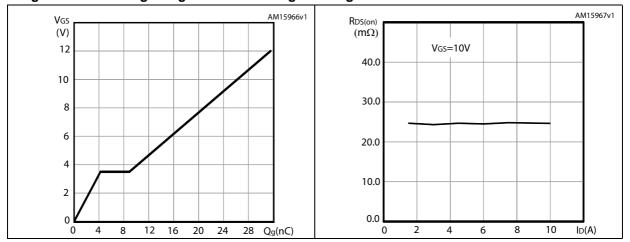
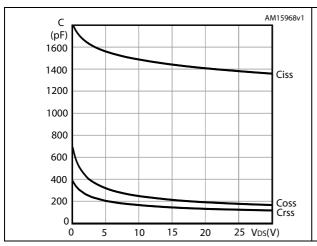


Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature



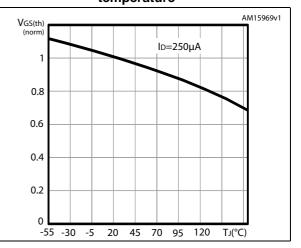
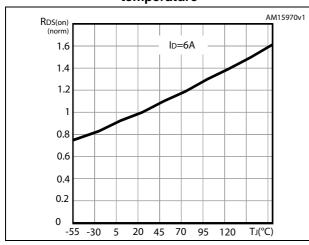


Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized $\rm V_{\rm DS}$ vs temperature



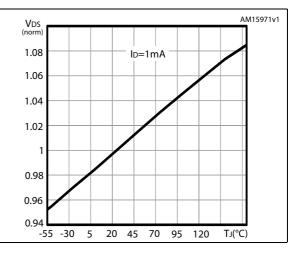
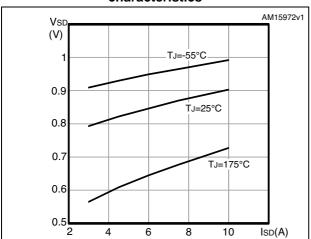


Figure 12. Source-drain diode forward characteristics



Test circuits STD26P3LLH6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

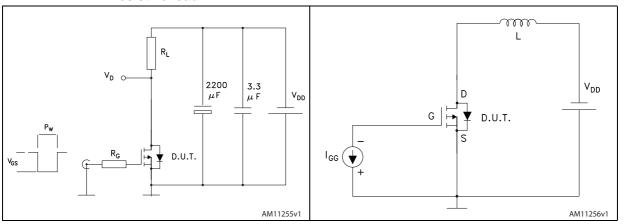


Figure 15. Test circuit for diode recovery behavior

Figure 16. Unclamped inductive load test circuit

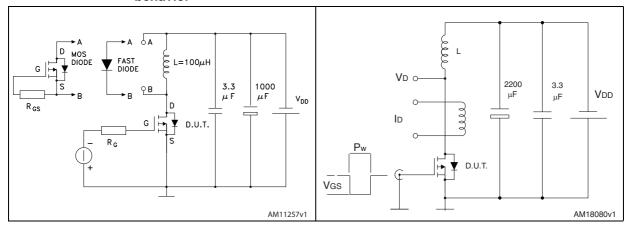
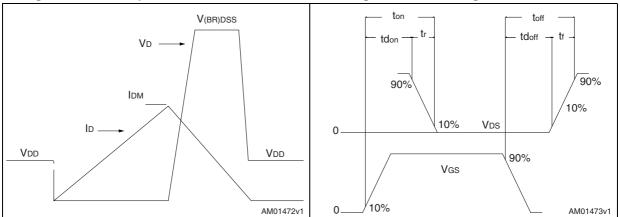


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



577

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



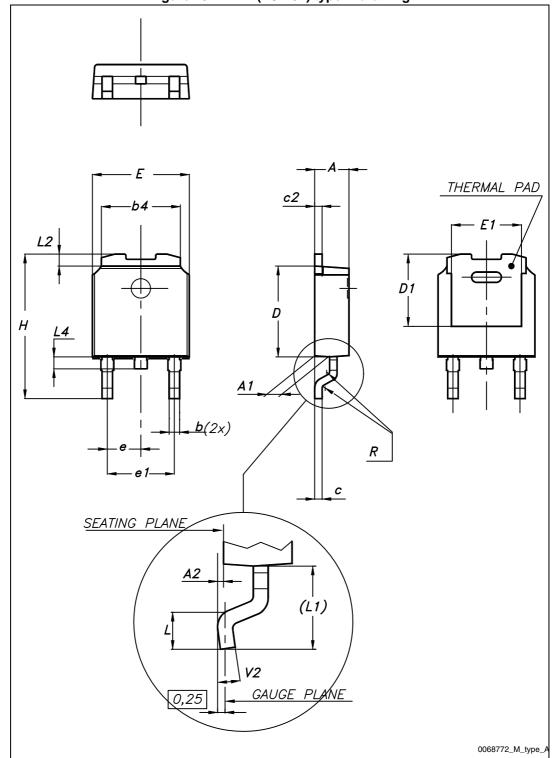


Figure 19. DPAK (TO-252) type A drawing



Table 9. DPAK (TO-252) type A mechanical data

D:	1000001217111(10	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
(L1)		2.80	
L2		0.80	
L4	0.60		1.00
R		0.20	
V2	0°		8°



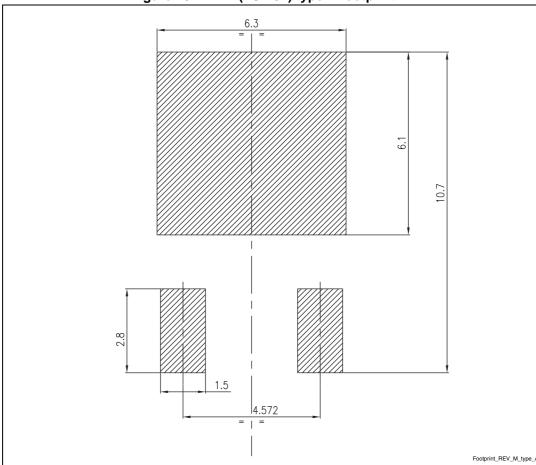


Figure 20. DPAK (TO-252) type A footprint ^(a)

DocID023574 Rev 5

a. All dimensions are in millimeters

5 Packaging mechanical data

10 pitches cumulative tolerance on tape +/- 0.2 mm

Top cover promotion ref. only including draft and radii concentric around B0

User direction of feed

AM08852v1

Figure 21. Tape for DPAK (TO-252)

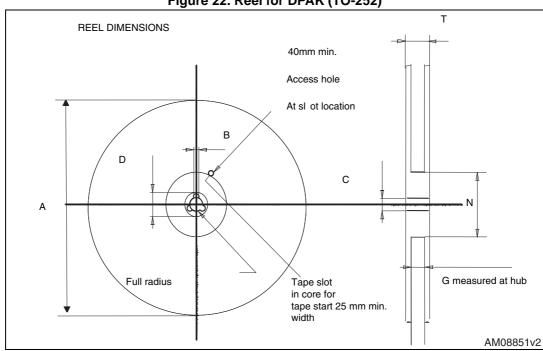


Figure 22. Reel for DPAK (TO-252)

Table 10. DPAK (TO-252) tape and reel mechanical data

Таре				Reel	
Dim.	m	mm		m	nm
Dilli.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	Α		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

14/16 DocID023574 Rev 5

STD26P3LLH6 Revision history

6 Revision history

Table 11. Document revision history

Date	Revision	Changes
22-Aug-2012	1	First release
31-Jan-2013	2	 Modified: R_{DS(on)} on the title, Features table and Table 5 Modified: typical values on Table 6, 7, 8 Modified: V_{SD} max value on Table 8 Updated: Section 4: Package mechanical data
16-Jul-2013	3	 Modified: V_{GS} and I_D=100 °C values in <i>Table 2</i> Modified: R_{DS(on)} max value in <i>Table 5</i>, <i>Figure 13</i>, <i>14</i> and <i>15</i> Inserted: Section 2.1: Electrical characteristics (curves)
10-Sep-2013	4	- Updated Q _g value in <i>Table 6: Dynamic</i> .
06-Feb-2014	5	 Added: Table 4: Avalanche characteristics Modified: Figure 2, 5 and 12 Updated: Section 4: Package mechanical data Added: Figure 16, 17 and 18 Minor text changes

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2014 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

16/16 DocID023574 Rev 5

